

07-31-2009

Form PTO-1595 (Rev. 03-09)  
OMB No. 0651-0027 (exp. 03/31/2009)



RECORDATION FORM COVER SHEET  
PATENTS ONLY

103569192

To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

50-3-2009

1. Name of conveying party(ies):

Tetsuro Yamamoto (07/06/2009), Junichi Yamashita (07/07/2009), Katsuhide Uchino (07/07/2009), and

Additional name(s) of conveying party(ies) attached?  Yes  No

2. Name and address of receiving party(ies)

Name: Sony Corporation

Internal Address: \_\_\_\_\_

Street Address: \_\_\_\_\_

1-7-1 Konan  
Minato-Ku, Tokyo  
108-0075  
JAPAN

City: \_\_\_\_\_

State: \_\_\_\_\_

Country: \_\_\_\_\_ Zip: \_\_\_\_\_

Additional name(s) & address(es) attached?  Yes  No

3. Nature of conveyance/Execution Date(s):

Execution Date(s): in parentheses after inventor name

- Assignment  Merger  Change of Name
- Security Agreement  Joint Research Agreement
- Government Interest Assignment
- Executive Order 9424, Confirmatory License
- Other \_\_\_\_\_

4. Application or patent number(s):

This document is being filed together with a new application.

A. Patent Application No.(s)

This application

B. Patent No.(s)

Additional numbers attached?  Yes  No

5. Name and address to whom correspondence concerning document should be mailed:

Name: Christopher M. Tobin  
RADER, FISHMAN & GRAUER PLLC

Internal Address: Atty. Dkt.: SON-4267  
Street Address: 1233 20th Street, N.W.  
Suite 501

City: Washington  
State: DC Zip: 20036

Phone Number: (202) 955-3750

Fax Number: (202) 955-3751

Email Address: cmt@raderfishman.com

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00

- Authorized to be charged to deposit account
- Enclosed
- None required (government interest not affecting title)

8. Payment Information

Deposit Account Number 18-0013

Authorized User Name Christopher M. Tobin

9. Signature:

Signature

Christopher M. Tobin - 40,290

Name of Person Signing

07/30/2009 DBYRNE 0000067-180013 12458810

01 FC:8621 48.00 DA Date

Total number of pages including cover sheet, attachments, and documents:

4

**RECORDATION FORM COVER SHEET (PTO-1595)  
(supplemental sheet)**

**Additional Conveying Party(ies)/Execution Date(s) (1. Continued):**

Seiichiro Jinta (07/13/2009)

**Additional Assignees (2. Continued):**

Assignee Name: \_\_\_\_\_

Internal Address:

Street Address:

City: \_\_\_\_\_ State: \_\_\_\_\_ Country: \_\_\_\_\_ Zip: \_\_\_\_\_

Assignee Name: \_\_\_\_\_

Internal Address:

Street Address:

City: \_\_\_\_\_ State: \_\_\_\_\_ Country: \_\_\_\_\_ Zip: \_\_\_\_\_

Assignee Name: \_\_\_\_\_

Internal Address:

Street Address:

City: \_\_\_\_\_ State: \_\_\_\_\_ Country: \_\_\_\_\_ Zip: \_\_\_\_\_

**Additional Applications and/or Patents (4. Continued):**

Additional Patent Application Numbers

4A. Continued:

Additional Patent Numbers

4B. Continued:

Additional numbers attached?

Yes

No

**ASSIGNMENT**

WHEREAS, I, as below named inventors, residing at the addresses stated next to our names, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in

**DISPLAY DEVICE AND ELECTRONIC APPARATUS**

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, SONY CORPORATION, a Japanese corporation, with offices at 1-7-1 Konan, Minato-ku, Tokyo, Japan (hereinafter referred to as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: \_\_\_\_\_, Filing Date: \_\_\_\_\_.

This assignment executed on the dates indicated below.

TETSURO YAMAMOTO  
Name of first or sole inventor  
KANAGAWA JAPAN  
Residence of First or sole inventor  
*Tetsuro Yamamoto*  
Signature of first or sole inventor

Execution date of U.S. Patent Application  
*July 6, 2009*  
Date of this assignment

JUNICHI YAMASHITA  
Name of second inventor  
TOKYO JAPAN  
Residence of second inventor  
*Junichi Yamashita*  
Signature of second inventor

Execution date of U.S. Patent Application  
*July 7, 2009*  
Date of this assignment

KATSUhide UCHINO  
Name of third inventor  
KANAGAWA JAPAN  
Residence of third inventor  
*Katsuhide Uchino*  
Signature of third inventor

Execution date of U.S. Patent Application  
*July 7, 2009*  
Date of this assignment

**ADDITIONAL INVENTOR(S)**

SEIICHIRO JINTA

Name of fourth inventor  
AICHI JAPAN

Residence of fourth inventor

Signature of fourth inventor  
*Seiichiro Jinta*

Execution date of U.S. Patent Application

Date of this assignment  
*July 13, 2009*

Name of fifth inventor

Residence of fifth inventor

Signature of fifth inventor

Execution date of U.S. Patent Application

Date of this assignment

Name of sixth inventor

Residence of sixth inventor

Signature of sixth inventor

Execution date of U.S. Patent Application

Date of this assignment

Name of seventh inventor

Residence of seventh inventor

Signature of seventh inventor

Execution date of U.S. Patent Application

Date of this assignment

Name of eighth inventor

Residence of eighth inventor

Signature of eighth inventor

Execution date of U.S. Patent Application

Date of this assignment

Name of ninth inventor

Residence of ninth inventor

Signature of ninth inventor

Execution date of U.S. Patent Application

Date of this assignment